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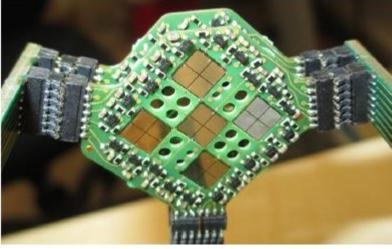
GSI Helmholtzzentrum für Schwerionenforschung GmbH

# TCT characterization of new generation of Dol samples



## **Diamond particle detectors**

- typical use of diamond as a particle detector:
  - timing (fast rise time)
  - rate (short signals)
- major advantages:
  - Iow leakage current
  - operating temperature range
  - radiation hardness
- commercially available materials
  - single crystal or polycrystalline materials
  - charge collection efficiency of PCDia is significantly lower than SCDia, but SCDia are available only in small sizes
  - especially for minimum-ionizing particles large area & high CCE

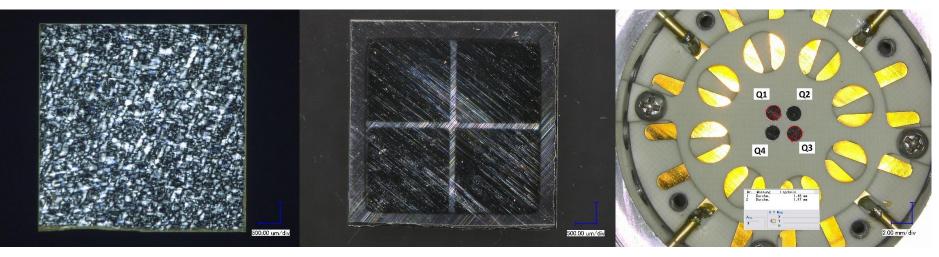


W. Koenig, J. Pietraszko, HADES Collaboration



## Heteroepitaxially grown diamonds

- R&D project with University of Augsburg
- heteroepitaxially films grown on Ir (diamond-on-iridium)
- buffer layer of yttrium-stabilized zirconium oxide on Si wafer is used to stabilize iridium terminated substrate
- diamonds prepared for characterization at GSI

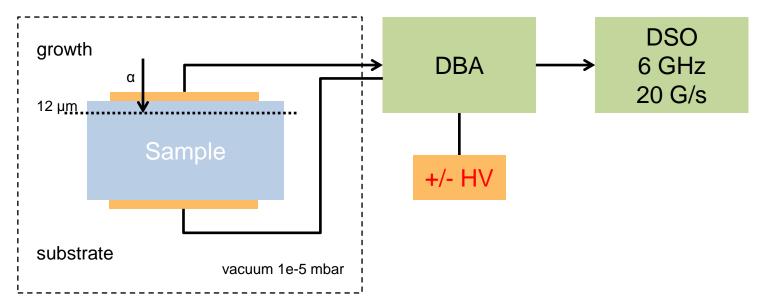


S. Gsell et al., Appl. Phys. Lett. 84, 4541 (2004)



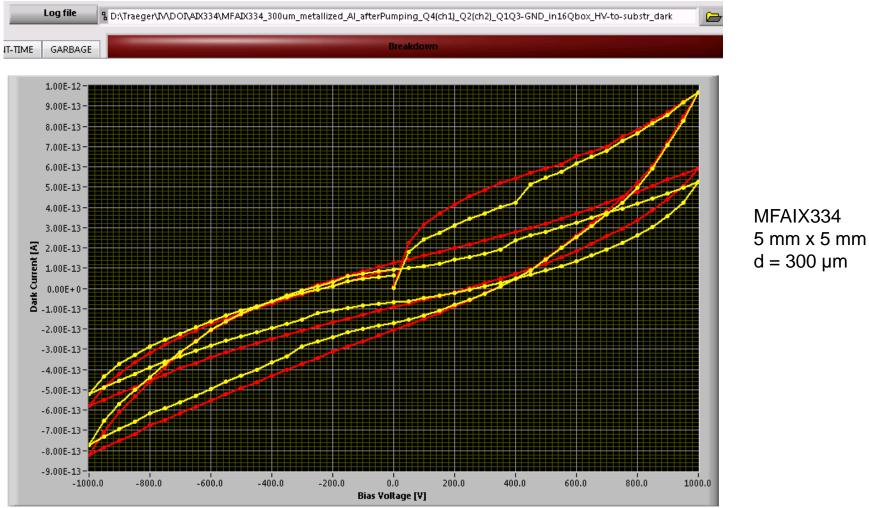
#### **Dol characterization**

- transition current technique, alpha-emitter, 5.5 MeV
- using alpha source to induce charge in a shallow layer close to surface, carrier drift is depending on biasing
- electrodes: Al, Cr/Au, Ti/Pt/Au
- diamond broad-band amplifier BW=2.3 GHz, G~40dB



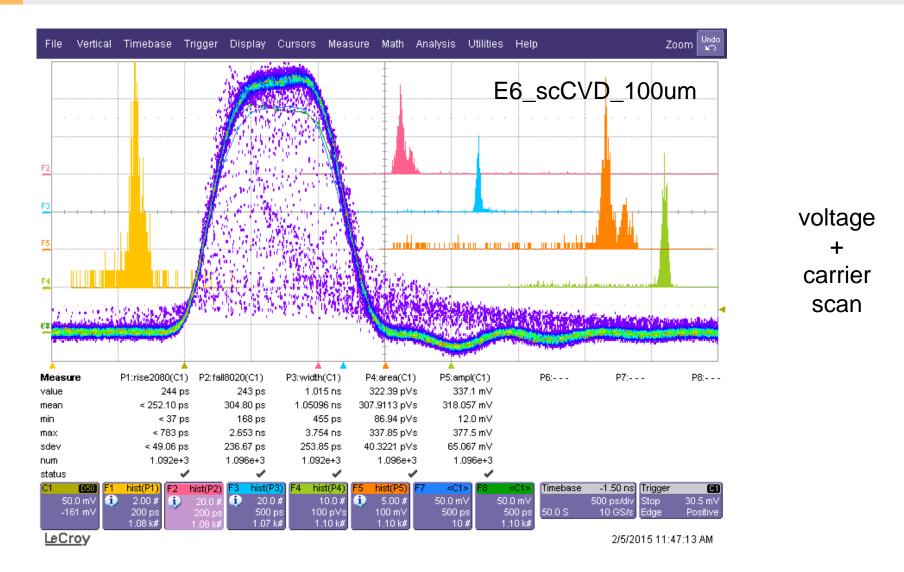


#### **V-I** measurement





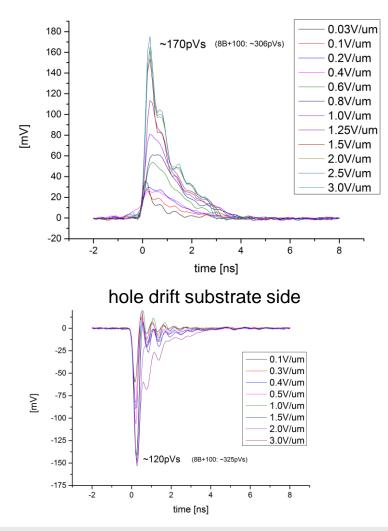
## Waveform acquisition





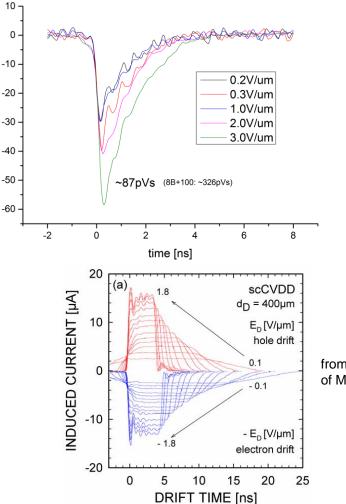
# Initial TCT waveforms (MFAIX334)

hole drift



electron drift

[mV]

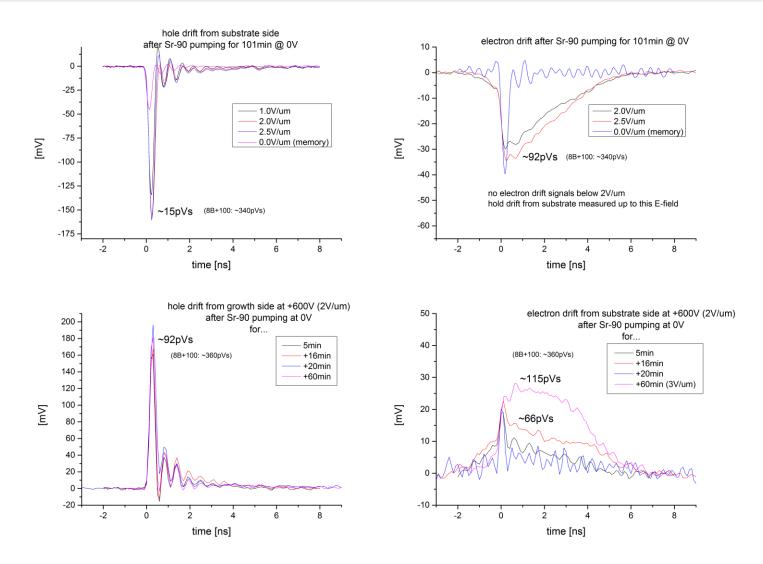


from PhD Thesis of M. Pomorski

4th ADAMAS Workshop: TCT characterization of new generation of Dol samples

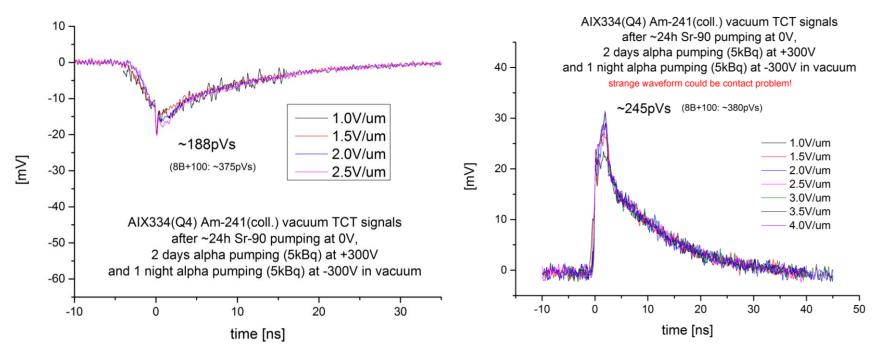


#### **TCT** waveforms after Sr-90 pumping





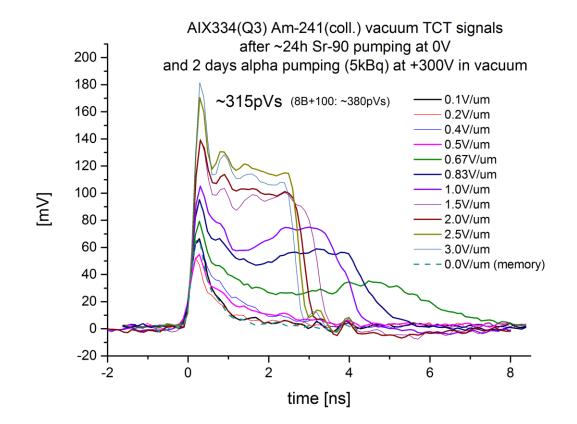
#### TCT waveforms after prolonged α-pumping



- significant signal in efficiency after alpha-pumping for both electrons and holes
- under study
- possible contact problem



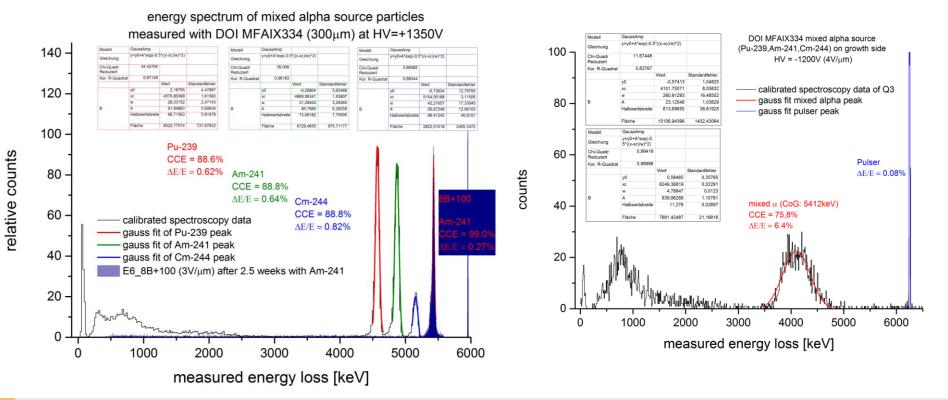
 after prolonged alpha pumping signals are indicating very small amount of active defects





## **Charge collection efficiency**

- charge-sensitive preamplifier (CSTA2) + Ortec 672
  spectroscopy amplifier + Silena 4418V peak-sensing ADC
- CCE(preliminary): ~90% for holes and ~76% electrons



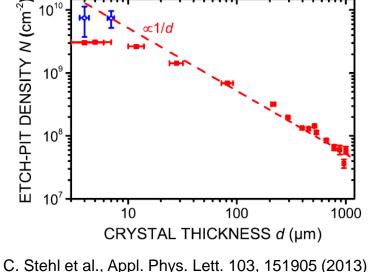


# **Dol development**

- the best overall characteristics for the last five years
- improved electron transport and material homogeneity
- Dol for detector applications, but no spectroscopy
- further improvements difficult; dislocation density is slowly decreasing -> another approach to growing: epitaxial lateral overgrowth

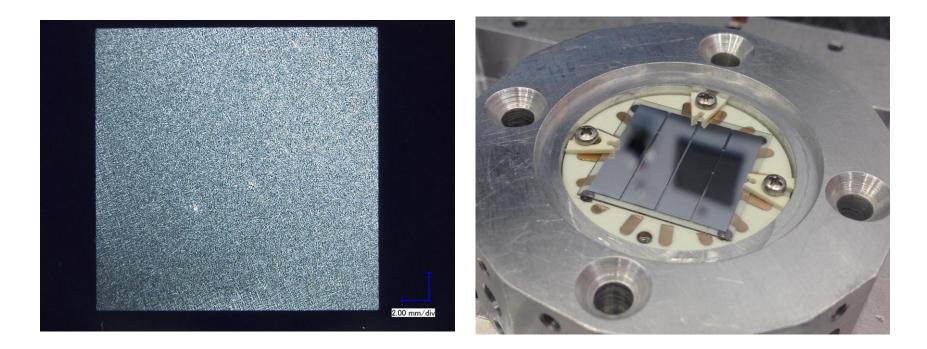
		CCE [%]		Ε_σ [%]	
Year	sample	hole	electron	hole	electron
2010	886-2	92.5	18.6	2.05	5.23
2011	952-1	79.4	19.7	11.1	42.8
2011	954	92.3	52.2	3	27.4
2012	955-1	77.1	51.2	13.2	28.6
2013	962	87	50.7	3.1	10.8
2014	AIX334	84.5	61	0.84	9

#### all values for fields 1.5V/µm





#### **Characterization of "large" Dol sample**

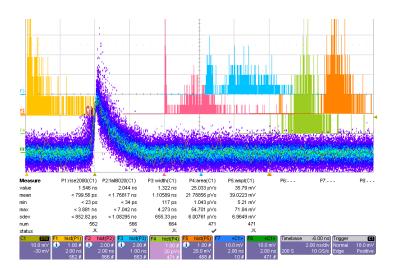


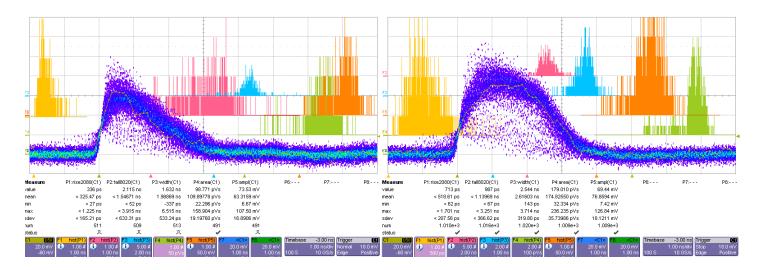
- MFAIX239L
- 20 x 20 mm<sup>2</sup>, ~300 µm, surface slanted
- metallization: Al 4-strips

#### Waveforms positive polarization (hole drift)



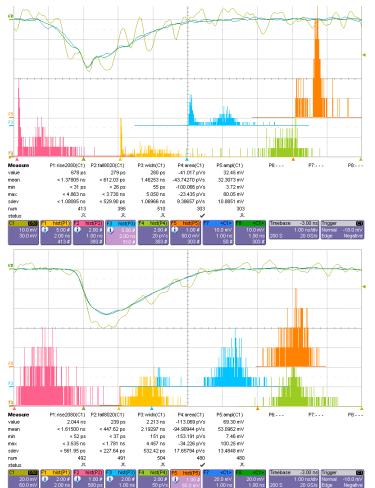
- setup in air
- non-pumped sample
- hole drift
- voltages 50V, 600 V, 1200 V

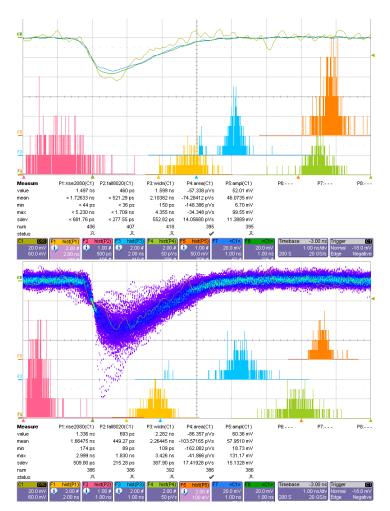






#### **300, 600, 900, 1150 V**



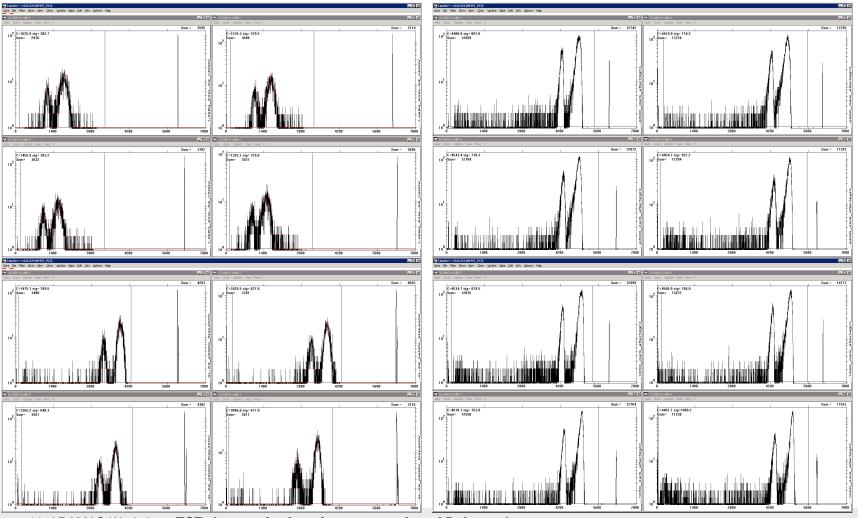




# **Spectroscopy Am-241**

-/+ 600 V, not pumped

#### Sr-90 pumped over night +600/1050V





# Summary

- the latest generation of Dol samples is showing a significant improvement in CCE i.e. sample quality
- Dol material cannot be compared to homoepitaxially grown diamonds yet, at least not to the detector grade material, the concentration of defects is comparably much higher and requires conditioning of detector
- additional study of material is needed
- nevertheless, the present level of performance is way beyond pcCVD and therefore makes Dol a material of choice for construction of new detector devices
- next step is construction of Dol detector device: a high rate MiP beam profile + timing detector